Abstract

This application note describes how to create a low power static LCD driver using a Dialog GreenPAK IC.

This application note comes complete with design files which can be found in the References section.
Static LCD Driver with I2C Interface

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# Terms and Definitions

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<thead>
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<th>Definition</th>
</tr>
</thead>
<tbody>
<tr>
<td>AC</td>
<td>Alternate current</td>
</tr>
<tr>
<td>ASIC</td>
<td>Application specific integrated circuit</td>
</tr>
<tr>
<td>ASM</td>
<td>Asynchronous state machine</td>
</tr>
<tr>
<td>CPLD</td>
<td>Complex programmable logic device</td>
</tr>
<tr>
<td>DC</td>
<td>Direct current</td>
</tr>
<tr>
<td>ICs</td>
<td>Integrated Circuits</td>
</tr>
<tr>
<td>LCD</td>
<td>Liquid crystal displays</td>
</tr>
</tbody>
</table>

# References

For related documents and software, please visit:


Download our free GreenPAK Designer software [1] to open the .gp files [2] and view the proposed circuit design. Use the GreenPAK development tools [3] to freeze the design into your own customized IC in a matter of minutes. Dialog Semiconductor provides a complete library of application notes [4] featuring design examples as well as explanations of features and blocks within the Dialog IC.


[6] Application Note AN-005 – Display Modes, Hitachi

3 Introduction

Liquid Crystal Displays (LCD) are widely used for commercial and industrial applications because of their good visual properties, low cost and, low power consumption. These properties make the LCD the standard solution for battery-operated devices, like portable instruments, calculators, watches, radios, etc.

However, to properly control what the LCD shows, the LCD’s electronic driver must generate appropriate voltage waveforms to LCD pins. The waveforms should be AC (alternate current) in nature because DC (direct current) voltages will permanently damage the device. The appropriate driver would source these signals to LCD at a minimum of power consumption.

Two types of LCDs exist, the Static, with only one backplane and one pin for individual segment control and, the Multiplexed, with multiple backplanes and multiple segments connected for each pin.

This application note will present the design of one static LCD driver with SLG46537V GreenPAK™ device. The designed LCD driver would drive up to 15 LCD’s segments, using a few microamperes of current from the power supply and offer an I2C interface for control.

In the following sections will be shown:

- basic knowledge information about LCDs;
- the SLG46537V GreenPAK LCD driver design in detail;
- how to drive a seven segment, 4-digit static LCD with two GreenPAK devices;

4 Basics of Liquid Crystal Displays

Liquid Crystal Displays (LCD) is a technology that does not emit light, it only controls how an external light source passes through. This external light source could be the available ambient light, in the reflective display type, or the light from a backlight led or lamp, in transmissive display type.

LCDs are constructed with two plates of glass (upper and bottom), a thin layer of liquid crystal (LC) between them and two light polarizers [5][6]. The polarizer is a light filter for the light electromagnetic field. Only the light components in the right electromagnetic field direction pass through the polarizer, while the other components are blocked. The liquid crystal is an organic material that rotates the electromagnetic field of the light 90 degrees or more. However, when an electrical field is applied to the LC it does not rotate the light anymore. With the addition of transparent electrodes in the upper and bottom display glass, its possible to control when the light passes through, and when not, with an external source of the electrical field. Figure 1 below illustrates this operation control. In Figure 1, the display is dark when there isn’t an electrical field. This is because both polarizers filter the light in the same direction. If the polarizers are orthogonal, then the display will be dark when the electrical field is present. This is the most common situation for reflective displays.
The minimum electrical field, or voltage, to control the LCD is called the ON threshold. The LC is only affected by the voltage, and there is hardly any current in LC material. The electrodes in LCD forms a small capacitance and this is the only load for a driver. This is the reason for an LCD being a low power device to show visual information.

However, it's important to note that the LCD can't operate with a direct current (DC) voltage source for too long. The application of a DC voltage will cause chemical reactions in LC material, permanently damaging it \[5\]. The solution is to apply an alternate voltage (AC) in LCDs electrodes.

In static LCDs, a backplane electrode is built in one glass and individual LCD's segments, or pixels, are put in the other glass. This is one of the simplest LCD types and the one with the best contrast ratio. However, this type of display usually requires too many pins to control each individual segment.

In general, a driver controller sources a square wave clock signal for the backplane and a clock signal for the segments in the front plane together. When the backplane clock is in-phase with the segment clock, the root-mean-square (RMS) voltage between both planes is zero, and the segment is transparent. Otherwise, if the RMS voltage is higher than LCD ON threshold, the segment becomes dark. The waveforms for the backplane, on and off segment are shown in Figure 2. As can be seen in the figure, the ON segment is out-of-phase in relation to the backplane signal. The off segment is in-phase in relation to the backplane signal. The applied voltage could be between 3 and 5 volts for low cost, low power displays.

The clock signal for LCD’s backplane and segments usually are in the range of 30 to 100 Hz, the minimum frequency to avoid a visual flicker effect on LCD. Higher frequencies are avoided to reduce the power consumption of the overall system. The system composed of LCD and drivers would consume little current, in the order of microamperes. This makes them perfectly suitable for low power and battery power supply source applications.
In the following sections, the design of an LCD static driver with GreenPAK device that can generate the backplane clock signal and the individual segment clock signal for a commercial LCD is presented in detail.

5 GreenPAK Design Basic Block Diagram

A block diagram that illustrates the GreenPAK design is shown in Figure 3. The basic blocks of the design are the I2C interface, the output segment driver, the internal oscillator, and the backplane clock source selector.

The I2C interface block controls each individual segment output and the backplane clock source of the LCD. The I2C interface block is the only system input for segment output control.

When the internal segment control line is set (high level) the respective LCD segment is dark opaque. When the internal segment control line is reset (low level) the respective LCD segment is transparent.

Each internal segment control line is connected to an output driver. The output segment driver block will generate an in-phase clock signal with relationship to the backplane clock for transparent segments. For dark segments, this signal is out of phase with relationship to backplane clock.

The backplane clock source is selected with I2C interface too. When the internal backplane clock source is selected, the internal oscillator is turned on. The internal oscillator will generate a clock frequency of 48Hz. This signal will be used by output segment driver block and is addressed to the backplane clock output pin (GreenPAK pin 20).

When external backplane clock source is selected, the internal oscillator is turned off. The output segment driver reference is the external backplane clock input (GreenPAK pin 2). In this case, the backplane clock output pin could be used as an additional segment control line, the segment OUT15.

More than one GreenPAK device could be used on the same I2C line. To do it, each device must be programmed with a different I2C address. In this way is possible to extend the number of LCD segments driven. One device is configured to generate the backplane clock source, driving 14...
segments, and the others are configured to use an external backplane clock source. Each additional device could drive more 15 segments in this way. It is possible to connect up to 16 devices on the same I2C line and then is possible to control up to 239 segments of an LCD.

In this application note, this idea is used to control 29 segments of an LCD with 2 GreenPAK devices. The device pinout functionality is summarized in Table 1.

### Table 1: Pinout Description for LCD Driver Design

<table>
<thead>
<tr>
<th>PIN</th>
<th>Design Function</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>Power Supply</td>
</tr>
<tr>
<td>2</td>
<td>Backplane clock input</td>
</tr>
<tr>
<td>3</td>
<td>Segment output 1 (SEG_OUT_1)</td>
</tr>
<tr>
<td>4</td>
<td>Segment output 2 (SEG_OUT_2)</td>
</tr>
<tr>
<td>5</td>
<td>Segment output 3 (SEG_OUT_3)</td>
</tr>
<tr>
<td>6</td>
<td>Segment output 4 (SEG_OUT_4)</td>
</tr>
<tr>
<td>7</td>
<td>Segment output 5 (SEG_OUT_5)</td>
</tr>
<tr>
<td>8</td>
<td>SCL</td>
</tr>
<tr>
<td>9</td>
<td>SDA</td>
</tr>
<tr>
<td>10</td>
<td>Segment output 6 (SEG_OUT_6)</td>
</tr>
<tr>
<td>11</td>
<td>Ground</td>
</tr>
<tr>
<td>12</td>
<td>Segment output 7 (SEG_OUT_7)</td>
</tr>
<tr>
<td>13</td>
<td>Segment output 8 (SEG_OUT_8)</td>
</tr>
<tr>
<td>14</td>
<td>Segment output 9 (SEG_OUT_9)</td>
</tr>
<tr>
<td>15</td>
<td>Segment output 10 (SEG_OUT_10)</td>
</tr>
<tr>
<td>16</td>
<td>Segment output 11 (SEG_OUT_11)</td>
</tr>
<tr>
<td>17</td>
<td>Segment output 12 (SEG_OUT_12)</td>
</tr>
<tr>
<td>18</td>
<td>Segment output 13 (SEG_OUT_13)</td>
</tr>
<tr>
<td>19</td>
<td>Segment output 14 (SEG_OUT_14)</td>
</tr>
<tr>
<td>20</td>
<td>Backplane clock output OR Segment output 15 (SEG_OUT_15)</td>
</tr>
</tbody>
</table>

### 6 Design Current Consumption

An important concern in this design is the current consumption, that should be as low as possible. The GreenPAK device estimated quiescent current is 0.75 µA for 3.3 V supply operation and 1.12 µA for 5 V supply operation. The current consumption of the internal oscillator is 7.6 µA and 8.68 µA for 3.3 V and 5 V power supply operation respectively. It is not expected to have a significant increase in current consumption from switching losses, because this design operates at a low clock frequency. The estimated maximum current consumed for this design is lower than 15 µA when the internal oscillator is on, and 10 µA when the internal oscillator is off. The measured current consumed in both situations is shown in Section 1710 - Test Results.
7 GreenPAK Device Schematic

The project designed in GreenPAK software is shown in Figure 4. This schematic will be described using the basic blocks diagrams as the reference.

Figure 4: Top View of the GreenPAK Design Schematic

7.1 I2C Interface

I2C interface block is used as the main control block of the device operation control. A close view to the block connections and configured properties are shown in Figure 5.

Figure 5: Close View to I2C Interface Block
This block is connected to PIN 8 and PIN 9, that are I2C SCL and SDA pins respectively. Inside the device, the I2C block offers 8 Virtual Inputs. The initial value for each Virtual Input is shown in the properties window (see Figure 5). Virtual inputs from OUT0 until OUT6 are used as segment control lines. These control lines correspond to segment output 1 to segment output 7 and are connected to the segment output driver. Virtual Input OUT7 is used as backplane clock source selector line control, with net name BCKP_SOURCE. This net will be used by other blocks in the design. The I2C control code is configured with a different value for each IC in the project.

8 more internal segment control lines are available in the Asynchronous State Machine (ASM) output, as shown in Figure 6 below. Segment output line 8 (SEG_OUT_8 in properties window) through segment output line 15 (SEG_OUT_15) are controlled by ASM output on state 0. There isn’t any state transition in ASM block, it is always in state 0. The outputs of ASM are connected to segment output drivers. The segment output drivers will generate the output signal of the device.

![Figure 6: ASM Output Used as Internal Segment Control](image)

### 7.2 Output Segment Driver

The output segment driver is essentially a Lookup table (LUT) configured as an XOR logic port. For each output segment, it must be an XOR port connected to segment control line and to backplane clock (BCKP_CLOCK). The XOR port is responsible to generate the in-phase and out-of-phase signal to output segment. When the segment control line is at a high level, the XOR port output will invert the backplane clock signal and generate an out-of-phase signal to segment pin. The voltage difference between LCD backplane and LCD segment, in this case, will set the LCD segment as a dark segment. When the segment control line is at a low level, the XOR port output will follow the backplane clock signal and then generate an in-phase signal to segment pin. Because no voltage is applied between the LCD backplane and segment in this case, the segment is transparent to light.

### 7.3 4.3 Internal Oscillator and Backplane Clock Source Control

The internal oscillator is used when the signal BCKP_CLOCK from I2C interface is set to a high level. A close view of the clock source control diagram is shown in Figure 7 below.
The oscillator is configured as 25 kHz RC frequency, with the highest output divisor available at oscillator OUT0 (8/64). The entire configuration is seen in the properties window shown in Figure 7. In this way, the internal oscillator will generate a clock frequency of 48 Hz.

The oscillator is active only when BCKP_SOURCE signal is at a high level together with POR signal. This control is done by connecting these two signals to the NAND port of the 4-L1 LUT. The output of the NAND is then connected to the input of the oscillator power down control pin.

Signal BCKP_SOURCE controls the MUX built with 3-L10 LUT. When BCKP_SOURCE signal is at a low level, the backplane clock source comes from PIN2. When this signal is at a high level the backplane clock source comes from the internal oscillator.

7.4 Backplane Clock Output or Segment 15 Output Pin Control

Pin 20 in this design has a double function, which depends on the selected backplane clock source. The operation of this pin is controlled with one 4 input LUT, as shown in Figure 8. With a 4-bit LUT, it is possible to associate the operation of XOR port with an output MUX. When the BCKP_SOURCE signal is at a high level, the LUT output will follow the internal oscillator clock. Then pin 20 operates as a backplane clock output. When BCKP_SOURCE signal is at a low level, the LUT output will be the XOR operation between SEG_OUT_15, from ASM output, and backplane clock signal. The 4-bit LUT configuration to do this operation is shown in Figure 8.

8 LCD System Prototype

To demonstrate the use of the GreenPAK design solution, an LCD system prototype was assembled on a breadboard. For the prototype, a seven segment, 4-digit static LCD is driven by two GreenPAK devices on DIP board. One device (IC1) uses the internal oscillator to drive LCD backplane, and the
other device (IC2) uses this signal as backplane input reference. Both ICs are controlled over I2C interface by an STM32F103C8T6 microcontroller (MCU) in a minimum development board.

Figure 9 shows the schematic of the connections between the two GreenPAK ICs, the LCD display, and the MCU board. In the schematic, the GreenPAK device with U1 (IC1) reference drives LCD digit one and two (LCD left side). The GreenPAK device with U2 (IC2) reference drives LCD digit three and four, plus the COL segment (LCD right side). The power supply for both devices comes from the regulator in the microcontroller development board. Two removable jumpers between the power supply and VDD pins of each GreenPAK device are added for current measurement with a multimeter.

A picture of the assembled prototype is shown in Figure 10.
9  I2C Commands for LCD Control

The two GreenPAK devices on the breadboard are programmed with the same design, except by the Control Byte value. The control byte of IC1 is 0 (I2C address 0x00), while the I2C control byte is 1 (I2C address 0x10). The connections between display segments and device drivers are summarized in the table below.

Table 2: Segments and Device Drivers

<table>
<thead>
<tr>
<th>PIN</th>
<th>IO Number</th>
<th>Design Function</th>
<th>(U1) Display Connection</th>
<th>(U2) Display Connection</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>VDD</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>2</td>
<td>0</td>
<td>Backplane clock input</td>
<td></td>
<td>COM</td>
</tr>
<tr>
<td>3</td>
<td>1</td>
<td>Segment output 1</td>
<td>1G</td>
<td>3F</td>
</tr>
<tr>
<td>4</td>
<td>2</td>
<td>Segment output 2</td>
<td>1F</td>
<td>3A</td>
</tr>
<tr>
<td>5</td>
<td>3</td>
<td>Segment output 3</td>
<td>1A</td>
<td>3B</td>
</tr>
<tr>
<td>6</td>
<td>4</td>
<td>Segment output 4</td>
<td>1B</td>
<td>4G</td>
</tr>
<tr>
<td>7</td>
<td>5</td>
<td>Segment output 5</td>
<td>2G</td>
<td>4F</td>
</tr>
<tr>
<td>8</td>
<td>6</td>
<td>SCL</td>
<td></td>
<td></td>
</tr>
<tr>
<td>9</td>
<td>7</td>
<td>SDA</td>
<td></td>
<td></td>
</tr>
<tr>
<td>10</td>
<td>8</td>
<td>Segment output 6</td>
<td>2F</td>
<td>4A</td>
</tr>
<tr>
<td>11</td>
<td>GND</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>12</td>
<td>9</td>
<td>Segment output 7</td>
<td>2A</td>
<td>4B</td>
</tr>
<tr>
<td>13</td>
<td>10</td>
<td>Segment output 8</td>
<td>2B</td>
<td>4C</td>
</tr>
<tr>
<td>14</td>
<td>11</td>
<td>Segment output 9</td>
<td>2C</td>
<td>4D</td>
</tr>
</tbody>
</table>

Figure 10: System Prototype Picture. IC1 is on the Left Side and IC2 is on the Right Side
The connections were selected in this way to create a clearer schematic and to simplify assembling the breadboard connections.

The control of the segment's output is done by I2C write commands to I2C Virtual Inputs and ASM output registers. As described in the application note AN-1090 Simple I2C IO Controllers with SLG46531V [7], the I2C write command is structured as follows:

- Start;
- Control byte (R/W bit is 0);
- Word address;
- Data;
- Stop.

All the I2C write commands are made to Word Address 0xF4 (I2C Virtual Inputs) and 0xD0 (ASM Output for state 0). The commands to write in IC1 and control LCD digit 1 and 2 are summarized in Table 3. In the command sequence representation, the open bracket “[“ denotes the Start signal, and the close bracket “]” denotes the Stop signal.

### Table 3: I2C Command Sequence Description for IC1

<table>
<thead>
<tr>
<th>I2C Write command</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>[0x00, 0xF4, Byte0]</td>
<td>Assign a state value to segments 1 to 7. It configures the backplane oscillator (Most Significant Bit, MSB) too. In IC1 the MSB is always set. In this way, the IC1 is configured to source the backplane clock signal. Byte0 value is described below.</td>
</tr>
<tr>
<td>[0x00, 0xD0, Byte1]</td>
<td>Assign a state value to segments 8 to 15. Byte1 value is described below.</td>
</tr>
</tbody>
</table>

The two bytes above control segments of LCD digit 1 and digit 2 together. Here, the approach is to use an individual lookup table (LUT) in software for each digit, considering the segments in both bytes. The byte values from lookup table should be mixed using a bitwise OR operation, and then send to the IC. The Table 4 shown the Byte0 and Byte1 value for each numeric value that should be written in each display digit.
Table 4: Lookup Table to Write Numbers and Letters on LCD Digit 1 and 2

<table>
<thead>
<tr>
<th>Digit 1</th>
<th>Digit 2</th>
<th>Number/letter</th>
</tr>
</thead>
<tbody>
<tr>
<td>Byte0</td>
<td>Byte1</td>
<td>Byte0</td>
</tr>
<tr>
<td>0x8E</td>
<td>0x70</td>
<td>0xE0</td>
</tr>
<tr>
<td>0x88</td>
<td>0x10</td>
<td>0x80</td>
</tr>
<tr>
<td>0x8D</td>
<td>0x60</td>
<td>0xD0</td>
</tr>
<tr>
<td>0x8D</td>
<td>0x30</td>
<td>0xD0</td>
</tr>
<tr>
<td>0x8B</td>
<td>0x10</td>
<td>0xB0</td>
</tr>
<tr>
<td>0x87</td>
<td>0x30</td>
<td>0xF0</td>
</tr>
<tr>
<td>0x87</td>
<td>0x70</td>
<td>0xF0</td>
</tr>
<tr>
<td>0x8C</td>
<td>0x10</td>
<td>0xC0</td>
</tr>
<tr>
<td>0x8F</td>
<td>0x70</td>
<td>0xF0</td>
</tr>
<tr>
<td>0x8F</td>
<td>0x10</td>
<td>0xF0</td>
</tr>
<tr>
<td>0x8F</td>
<td>0x50</td>
<td>0xF0</td>
</tr>
<tr>
<td>0x83</td>
<td>0x70</td>
<td>0xB0</td>
</tr>
<tr>
<td>0x86</td>
<td>0x60</td>
<td>0xE0</td>
</tr>
<tr>
<td>0x89</td>
<td>0x70</td>
<td>0x90</td>
</tr>
<tr>
<td>0x87</td>
<td>0x60</td>
<td>0xF0</td>
</tr>
<tr>
<td>0x87</td>
<td>0x40</td>
<td>0xF0</td>
</tr>
</tbody>
</table>

For example, to write in the Digit 1 the number 3, and in the Digit 2 the number 4, Byte0 is 0xBD (0x8D bitwise OR with 0xB0) and Byte 1 is 0x33 (0x30 bitwise OR with 0x03).

The command to write in IC2 and controls Digit 3 and 4, are described in Table 5.

Table 5: I2C Command Sequence Description for IC2

<table>
<thead>
<tr>
<th>I2C Write command</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>[0x10, 0xF4, Byte0]</td>
<td>Assign a state value to segments 1 to 7. It configures the backplane oscillator (Most Significant Bit, MSB). In IC2 the MSB is always reset. In this way, the IC2 is configured to use an external source of backplane clock. This configuration enables an additional segment output to this IC (Segment output 15). Byte0 value is described below.</td>
</tr>
<tr>
<td>[0x10, 0xD0, Byte1]</td>
<td>Assign a state value to segments 8 to 15. Byte1 value is described below.</td>
</tr>
</tbody>
</table>

The control logic of digits 3 and 4 are like the control of digits 1 and 2. Table 6 shows the LUT for these two digits.

Table 6: Lookup Table to Write Numbers and Letters on LCD Digit 3 and 4

<table>
<thead>
<tr>
<th>Digit 3</th>
<th>Digit 4</th>
<th>Number/letter</th>
</tr>
</thead>
<tbody>
<tr>
<td>Byte0</td>
<td>Byte1</td>
<td>Byte0</td>
</tr>
<tr>
<td>0x07</td>
<td>0x38</td>
<td>0x70</td>
</tr>
<tr>
<td>0x04</td>
<td>0x8</td>
<td>0x40</td>
</tr>
<tr>
<td>0x06</td>
<td>0xB0</td>
<td>0x68</td>
</tr>
</tbody>
</table>
The difference in IC2 is the COL segment. This segment is controlled by Byte1. To set up this segment dark, a bitwise OR operation between the Byte1 and the value 0x40 should be done.

9.1 I2C Commands for LCD Test

For LCD test a firmware was developed in C language for the MCU board. This firmware will send a sequence of commands to both ICs on the breadboard. The source code for this firmware is in the Appendix section. The entire solution was developed using Atollic TrueStudio for STM32 9.0.1 IDE.

The sequence of commands and the respective values shown in the display are summarized in Table 7 below.

### Table 7: LCD Prototype Display Sequence

<table>
<thead>
<tr>
<th>Display text (all digits and COL :)</th>
<th>I2C Write command sequence (4 commands)</th>
</tr>
</thead>
<tbody>
<tr>
<td>88:88</td>
<td>[0x00, 0xF4, 0xFF], [0x00, 0xD0, 0x7F], [0x10, 0xF4, 0xFF], [0x10, 0xD0, 0xFF]</td>
</tr>
<tr>
<td>0000</td>
<td>[0x00, 0xF4, 0xEE], [0x00, 0xD0, 0x7F], [0x10, 0xF4, 0x77], [0x10, 0xD0, 0x3F]</td>
</tr>
<tr>
<td>1234</td>
<td>[0x00, 0xF4, 0xD8], [0x00, 0xD0, 0x1D], [0x10, 0xF4, 0x5E], [0x10, 0xD0, 0x99]</td>
</tr>
<tr>
<td>8765</td>
<td>[0x00, 0xF4, 0xCF], [0x00, 0xD0, 0x73], [0x10, 0xF4, 0x3B], [0x10, 0xD0, 0xBB]</td>
</tr>
<tr>
<td>EB9D</td>
<td>[0x00, 0xF4, 0xB7], [0x00, 0xD0, 0x6E], [0x10, 0xF4, 0x4F], [0x10, 0xD0, 0x8F]</td>
</tr>
<tr>
<td>12:00</td>
<td>[0x00, 0xF4, 0xD8], [0x00, 0xD0, 0x1D], [0x10, 0xF4, 0x77], [0x10, 0xD0, 0x7F]</td>
</tr>
<tr>
<td>1200</td>
<td>[0x00, 0xF4, 0xD8], [0x00, 0xD0, 0x1D], [0x10, 0xF4, 0x77], [0x10, 0xD0, 0x3F]</td>
</tr>
</tbody>
</table>
10 Test Results

The prototype test consists of verifying the display values after an MCU command and measuring the current sink by each IC during operation.

Pictures of the LCD for each command value are shown in Table 8 below.

Table 8: Pictures of LCD Display after MCU Commands to GreenPAK Devices

<table>
<thead>
<tr>
<th>Expected Display text.</th>
<th>Display picture</th>
</tr>
</thead>
<tbody>
<tr>
<td>88:88</td>
<td><img src="image" alt="88:88 display" /></td>
</tr>
<tr>
<td>0000</td>
<td><img src="image" alt="0000 display" /></td>
</tr>
<tr>
<td>1234</td>
<td><img src="image" alt="1234 display" /></td>
</tr>
<tr>
<td>8765</td>
<td><img src="image" alt="8765 display" /></td>
</tr>
<tr>
<td>EB9D</td>
<td><img src="image" alt="EB9D display" /></td>
</tr>
<tr>
<td>12:00</td>
<td><img src="image" alt="12:00 display" /></td>
</tr>
<tr>
<td>1200</td>
<td><img src="image" alt="1200 display" /></td>
</tr>
</tbody>
</table>

The current sink for each device was measured with a multimeter, in its lowest current range of 200 μA. Pictures of the measured current for each device, during start-up and normal operation, are shown in Table 9 below.
### Table 9: Current Measurements for Each GreenPAK Device

<table>
<thead>
<tr>
<th>Picture</th>
<th>Measured IC (power supply always at 3.3V)</th>
</tr>
</thead>
<tbody>
<tr>
<td><img src="image1.png" alt="Image" /></td>
<td>IC1 current during start-up (internal oscillator is off and there isn’t any external backplane clock source)</td>
</tr>
<tr>
<td><img src="image2.png" alt="Image" /></td>
<td>IC1 current in normal operation (internal oscillator is on and sources the backplane signal for the LCD display).</td>
</tr>
<tr>
<td><img src="image3.png" alt="Image" /></td>
<td>IC1 current in normal operation (internal oscillator is on and sources the backplane signal for the LCD display).</td>
</tr>
<tr>
<td><img src="image4.png" alt="Image" /></td>
<td>IC2 current in normal operation (internal oscillator is off, backplane clock signal comes from IC1).</td>
</tr>
</tbody>
</table>
11 Conclusion and Results Discussion

The design of a low power static LCD driver with GreenPAK device was presented. This design clearly shows one of the greatest features of the GreenPAK devices: their low quiescent current. Because GreenPAK devices are a hardware-based solution, it is possible to work at a low-frequency operation, in this case, 48 Hz. An MCU based solution will require a higher operation frequency, even for periodically short periods of time, and then will draw more power. And, comparing GreenPAK device with a CPLD (Complex Programmable Logic Device), it is clear to see that usually a CPLD has a quiescent current higher than 20 µA.

It is interesting to note that this design could be easily modified for a better fit in the requirements of a specific project. A good example is the segment controls pinout. They could easily be changed to simplify the printed circuit board and the software development at the same time. This is an interesting feature when the device is compared with an off-the-shelf ASIC (Application Specific Integrated Circuit). Usually, ASICs are designed to fit on a broad range of applications, and an initial software routine should be written to properly configure the IC before the operation. A configurable device could be designed to start ready to use after power up. In this way, it's possible to cut the software development time for IC initial configuration.
Appendix A

A.1 Source Code

/*
	******************************************************************************
	File:    stm32f1xx_it.c
	Info:   Main Interrupt Service Routines.
	******************************************************************************
	*/

uint32_t TickCount = 0;

/**
	******************************************************************************
	** Abstract: This function handles SysTick Handler.**
	******************************************************************************
	*/

void SysTick_Handler(void)
{
    TickCount++;,
}

/*
	******************************************************************************
	File:     main.c
	Info:     Demo code for static LCD driver with SLG46537V
	******************************************************************************
	*/

#include <stddef.h>
#include "stm32f10x.h"
#include "stm32f10x_conf.h"
#include "stm32f1xx_it.h"

// Basic definitions
#define ON_BOARD_LED_PIN    GPIO_Pin_13
#define ON_BOARD_LED_PORT   GPIOC
#define ON_BOARD_I2C_PORT   GPIOB
#define SDA_I2C_PIN         GPIO_Pin_7
#define SCL_I2C_PIN         GPIO_Pin_6
#define LED_TURN_ON()       GPIO_ResetBits(ON_BOARD_LED_PORT, ON_BOARD_LED_PIN)
#define LED_TURN_OFF()      GPIO_SetBits(ON_BOARD_LED_PORT, ON_BOARD_LED_PIN)
#define LCD_CONTROL_I2C     I2C1
#define I2C_TIMEOUT_VALUE   0xFF000000
#define TRUE                1
#define FALSE               0
#define BCKP_SOURCE_CTRL_BIT_MASK 0x80 // backplane source control bit mask
#define CONTROL_BYTE_IC1    0x00 // I2C address of device IC 1
#define CONTROL_BYTE_IC2    0x10 // I2C address of device IC 2
#define BYTE_0_ADDRESS      0xF4 // byte 0 config word address
#define BYTE_1_ADDRESS 0xD0 // byte 1 config word address

/* Test sequence command list to write on display */
const uint8_t TestDisplayCMDList[][4] =
{
    {0xEE, 0x7F, 0x77, 0x3F}, /* write "0000" on display */
    {0xD8, 0x1D, 0x5E, 0x99}, /* write "1234" on display */
    {0xCF, 0x73, 0x3B, 0xBB}, /* write "8765" on display */
    {0xB7, 0x6E, 0x4F, 0x8F}, /* write "EB9D" on display */
    {0xD8, 0x1D, 0x77, 0x7F}, /* write "12:00" on display */
    {0xD8, 0x1D, 0x3F} /* write "1200" on display */
};

/* LUT for LCD's Digit1 control */
const uint8_t Digit1ByteLUT[][2] =
{
    0x8E, 0x70, // 0
    0x88, 0x10, // 1
    0x8D, 0x60, // 2
    0x8D, 0x30, // 3
    0x8B, 0x10, // 4
    0x87, 0x30, // 5
    0x87, 0x70, // 6
    0x8C, 0x10, // 7
    0x8F, 0x70, // 8
    0x8F, 0x10, // 9
    0x8F, 0x50, // A
    0x83, 0x70, // B
    0x86, 0x60, // C
    0x89, 0x70, // D
    0x87, 0x60, // E
    0x87, 0x40 // F
};

/* LUT for LCD's Digit2 control */
const uint8_t Digit2ByteLUT[][2] =
{
    0xE0, 0x0F, // 0
    0x80, 0x03, // 1
    0xD0, 0x0D, // 2
    0xD0, 0x07, // 3
    0xBE, 0x03, // 4
    0xF0, 0x06, // 5
    0xF0, 0x0E, // 6
    0xC0, 0x03, // 7
    0xF0, 0x0F, // 8
    0xF0, 0x03, // 9
    0xF0, 0xFB, // A
    0xB0, 0x0E, // B
    0xE0, 0x0C, // C
    0x90, 0x0F, // D
    0xF0, 0x0C, // E
    0xF0, 0x08 // F
};

/* LUT for LCD's Digit3 control */
const uint8_t Digit3ByteLUT[][2] =
{...}
/* LUT for LCD's Digit4 control */
const uint8_t Digit4ByteLUT[][2] =
{
    0x70, 0x07,       //    0
    0x40, 0x01,       //    1
    0x68, 0x06,       //    2
    0x68, 0x03,       //    3
    0x58, 0x01,       //    4
    0x38, 0x03,       //    5
    0x38, 0x07,       //    6
    0x60, 0x01,       //    7
    0x78, 0x07,       //    8
    0x78, 0x01,       //    9
    0x78, 0x05,       //    A
    0x18, 0x07,       //    B
    0x30, 0x06,       //    C
    0x48, 0x07,       //    D
    0x38, 0x06,       //    E
    0x38, 0x04       //    F
};

void DelayMs(uint32_t delay_time)
{
    uint32_t ReferenceTick;
    uint32_t ExpectedTickCount;

    ReferenceTick = TickCount;
    ExpectedTickCount = ReferenceTick + delay_time;

    if(ExpectedTickCount < ReferenceTick)
    {
        while(TickCount > ExpectedTickCount)
        {
            // Code...
        }
    }
}
return;

while(TickCount < ExpectedTickCount)
{
}

/**
**===========================================================================
** Abstract: BoardConfigInit function initialize dev board
**===========================================================================
*/
void BoardConfigInit(void)
{
    GPIO_InitTypeDef GPIO_InitStruct;
    I2C_InitTypeDef I2C_InitStruct;

    // Clock PORTC and PORTB Enable
    RCC_APB2PeriphClockCmd(RCC_APB2Periph_GPIOC | RCC_APB2Periph_GPIOB, ENABLE);

    // Clock I2C1 Enable
    RCC_APB1PeriphClockCmd(RCC_APB1Periph_I2C1, ENABLE);

    // Configure the GPIO pin for the LED (PC13)
    GPIO_InitStruct.GPIO_Pin = ON_BOARD_LED_PIN;
    // Configure Led pin
    GPIO_InitStruct.GPIO_Speed = GPIO_Speed_50MHz;
    GPIO_InitStruct.GPIO_Mode = GPIO_Mode_Out_PP;
    // Set Output Push-Pull
    GPIO_Init(ON_BOARD_LED_PORT, &GPIO_InitStruct);

    // Configure the GPIO pins for the I2C interface (PB6 and PB7)
    GPIO_InitStruct.GPIO_Pin = SDA_I2C_PIN | SCL_I2C_PIN; // Configure SDA and SCL pins
    GPIO_InitStruct.GPIO_Speed = GPIO_Speed_50MHz;
    GPIO_InitStruct.GPIO_Mode = GPIO_Mode_AF_OD;
    // Set alternate function open drain
    GPIO_Init(ON_BOARD_I2C_PORT, &GPIO_InitStruct);

    // Configure I2C1 peripheral
    I2C_InitStruct.I2C_ClockSpeed = 20000;
    // 100 kHz I2C clock speed
    I2C_InitStruct.I2C_Ack = I2C_Ack_Disable;
    I2C_InitStruct.I2C_AcknowledgedAddress = 0x00;
    I2C_InitStruct.I2C_DutyCycle = I2C_DutyCycle_2;
    I2C_InitStruct.I2C_Mode = I2C_Mode_I2C;
    // Set as I2C interface
    I2C_InitStruct.I2C_OwnAddress1 = 0x00;
I2C_Init(LCD_CONTROL_I2C, &I2C_InitStruct);
    // set up I2C peripheral
I2C_Cmd(LCD_CONTROL_I2C, ENABLE);
    // enable I2C

    // ** Configures the SysTick event to fire every 1ms **
SysTick_Config(SystemCoreClock / 1000);
}

/**
**===========================================================================
**
**  Abstract: I2C_WriteByteCmd is a function to write commands in GreenPAK
**  devices. The function receives the ControlByte, Word Address and the
**  data byte.
**===========================================================================
*/
uint32_t I2C_WriteByteCmd(uint8_t ControlByte, uint8_t ByteAddress, uint8_t ByteData)
{
    uint32_t TimeoutCount;  // variable used to timeout routines
    TimeoutCount = I2C_TIMEOUT_VALUE; // set timeout value

    // wait until I2C bus is not busy anymore
    while(I2C_GetFlagStatus(LCD_CONTROL_I2C, I2C_FLAG_BUSY) == SET)
    {
        TimeoutCount--;  // decrements timeout counter
        if(TimeoutCount == 0) // Trigger timeout condition when
        {
            return FALSE;  // quit of the function
        }
    }

    TimeoutCount = I2C_TIMEOUT_VALUE; // set timeout value

    // generate start condition
    I2C_GenerateSTART(LCD_CONTROL_I2C, ENABLE);

    // wait until EV5 is triggered -> start condition correctly
    // released on the I2C bus
    while(I2C_CheckEvent(LCD_CONTROL_I2C, I2C_EVENT_MASTER_MODE_SELECT) == ERROR)
    {
        TimeoutCount--;  // decrements timeout counter
        if(TimeoutCount == 0) // Trigger timeout condition when
        {
            return FALSE;  // quit of the function
        }
    }
}
// send the control byte (I2C address)
I2C_Send7bitAddress(LCD_CONTROL_I2C, ControlByte, I2C_Direction_Transmitter);

TimeoutCount = I2C_TIMEOUT_VALUE; // set timeout value

// wait until EV6 is triggered -> Slave device ACK
while(I2C_CheckEvent(LCD_CONTROL_I2C, I2C_EVENT_MASTER_TRANSMITTER_MODE_SELECTED) == ERROR)
{
    TimeoutCount--; // decrements timeout
    if(TimeoutCount == 0) // Trigger timeout condition
    {
        // timeout
        return FALSE; // quit of the function
    }
}

TimeoutCount = I2C_TIMEOUT_VALUE; // set timeout value

// send the word/byte address to CMIC
I2C_SendData(LCD_CONTROL_I2C, ByteAddress);

// wait until EV8_2 is triggered -> Data shifted out on I2C bus
while(I2C_CheckEvent(LCD_CONTROL_I2C, I2C_EVENT_MASTER_BYTE_TRANSMITTED) == ERROR)
{
    TimeoutCount--; // decrements timeout
    if(TimeoutCount == 0) // Trigger timeout condition
    {
        // timeout
        return FALSE; // quit of the function
    }
}

TimeoutCount = I2C_TIMEOUT_VALUE; // set timeout value

// send the byte of data to CMIC
I2C_SendData(LCD_CONTROL_I2C, ByteData);

// wait until EV8_2 is triggered -> Data shifted out on I2C bus
while(I2C_CheckEvent(LCD_CONTROL_I2C, I2C_EVENT_MASTER_BYTE_TRANSMITTED) == ERROR)
{
    TimeoutCount--; // decrements timeout
    if(TimeoutCount == 0) // Trigger timeout condition
    {
        // timeout
        return FALSE; // quit of the function
    }
}
TimeoutCount = I2C_TIMEOUT_VALUE; // set timeout value

// generate stop condition on bus
I2C_GenerateSTOP(LCD_CONTROL_I2C, ENABLE);

return TRUE; // send TRUE when command finish
}

/**
**===========================================================================
**
** Abstract: FlashLed -> generate a timed flash on board led
**
**===========================================================================
*/
void FlashLed(uint32_t Ton, uint32_t Toff)
{
    LED_TURN_ON();
    DelayMs(Ton);
    LED_TURN_OFF();
    DelayMs(Toff);
}

/**
**===========================================================================
**
** Abstract: main program
**
**===========================================================================
*/
int main(void)
{
    uint8_t Temp;
    uint16_t DisplayValue = 1200;
    uint16_t Result;
    uint8_t Digit1;
    uint8_t Digit2;
    uint8_t Digit3;
    uint8_t Digit4;
    uint8_t TempByte0;
    uint8_t TempByte1;
    BoardConfigInit(); // init board peripherals

    /* flash led signal to advice demo begin */

    FlashLed(3000, 1000); // Hold board led on for 3 seconds

    for(Temp = 0; Temp < 5; Temp++) // short flash led 5 times
    {
        FlashLed(500, 500);
    }
/ Set all segments in as opaque
*/
I2C_WriteByteCmd(CONTROL_BYTE_IC1, BYTE_0_ADDRESS, 0xFF);
I2C_WriteByteCmd(CONTROL_BYTE_IC1, BYTE_1_ADDRESS, 0xFF);
I2C_WriteByteCmd(CONTROL_BYTE_IC2, BYTE_0_ADDRESS, 0x7F);
I2C_WriteByteCmd(CONTROL_BYTE_IC2, BYTE_1_ADDRESS, 0xFF);

*/
* 3 led flash
*/
for(Temp = 0; Temp < 3; Temp++)
{
    FlashLed(250, 500);
}

*/
* Send the list of demo commands to control display behavior
*/
for(Temp = 0; Temp < (sizeof(TestDisplayCMDList)/sizeof(uint8_t*)); Temp++)
{
    I2C_WriteByteCmd(CONTROL_BYTE_IC1, BYTE_0_ADDRESS, TestDisplayCMDList[Temp][0]);
    I2C_WriteByteCmd(CONTROL_BYTE_IC1, BYTE_1_ADDRESS, TestDisplayCMDList[Temp][1]);
    I2C_WriteByteCmd(CONTROL_BYTE_IC2, BYTE_0_ADDRESS, TestDisplayCMDList[Temp][2]);
    I2C_WriteByteCmd(CONTROL_BYTE_IC2, BYTE_1_ADDRESS, TestDisplayCMDList[Temp][3]);
    FlashLed(100, 1500);
}

*/
* flashing led fast - finish the code
*/
while(1)
{
    Result = DisplayValue / 1000; // get thousand digit
    Digit1 = (uint8_t) Result;
    Result = DisplayValue % 1000; // get hundred digit
    Result /= 100;
    Digit2 = (uint8_t) Result;
    // from digit 1 and 2 values mount byte 0 value
    TempByte0 = Digit1ByteLUT[Digit1][0];
    TempByte0 |= Digit2ByteLUT[Digit2][0];
    // from digit 1 and 2 values mount byte 1 value
    TempByte1 = Digit1ByteLUT[Digit1][1];
    TempByte1 |= Digit2ByteLUT[Digit2][1];
    // write new byte values to IC1 - update display
    I2C_WriteByteCmd(CONTROL_BYTE_IC1, BYTE_0_ADDRESS, TempByte0);
    I2C_WriteByteCmd(CONTROL_BYTE_IC1, BYTE_1_ADDRESS, TempByte1);
Result = DisplayValue % 100;
Result /= 10;
Digit3 = (uint8_t) Result;

Result = DisplayValue % 10;
Digit4 = (uint8_t) Result;

// from digit 3 and 3 values mount byte 0 value
TempByte0 = Digit3ByteLUT[Digit3][0];
TempByte0 |= Digit4ByteLUT[Digit4][0];

// from digit 3 and 4 values mount byte 1 value
TempByte1 = Digit3ByteLUT[Digit3][1];
TempByte1 |= Digit4ByteLUT[Digit4][1];

// write new byte values to IC2 - update display
I2C_WriteByteCmd(CONTROL_BYTE_IC2, BYTE_0_ADDRESS, TempByte0);
I2C_WriteByteCmd(CONTROL_BYTE_IC2, BYTE_1_ADDRESS, TempByte1);
// fast led flash
FlashLed(250, 250);

TempByte1 |= 0x40;        // set col segment

// write command to set col segment
I2C_WriteByteCmd(CONTROL_BYTE_IC2, BYTE_1_ADDRESS, TempByte1);
// fast led flash
FlashLed(250, 250);
// increment display value
DisplayValue++;
Revision History

<table>
<thead>
<tr>
<th>Revision</th>
<th>Date</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>1.0</td>
<td>16-Oct-2018</td>
<td>Initial Version</td>
</tr>
</tbody>
</table>
Static LCD Driver with I2C Interface

Status Definitions

<table>
<thead>
<tr>
<th>Status</th>
<th>Definition</th>
</tr>
</thead>
<tbody>
<tr>
<td>DRAFT</td>
<td>The content of this document is under review and subject to formal approval, which may result in modifications or additions.</td>
</tr>
<tr>
<td>APPROVED or unmarked</td>
<td>The content of this document has been approved for publication.</td>
</tr>
</tbody>
</table>

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Contacting Dialog Semiconductor

United Kingdom (Headquarters)
Dialog Semiconductor (UK) LTD
Phone: +44 1793 757700

Germany
Dialog Semiconductor GmbH
Phone: +49 7021 805-0

The Netherlands
Dialog Semiconductor B.V.
Phone: +31 73 640 8822

Email: enquiry@diasemi.com
Web site: www.dialog-semiconductor.com

North America
Dialog Semiconductor Inc.
Phone: +1 408 845 8500

Japan
Dialog Semiconductor K. K.
Phone: +81 3 5769 5100

Taiwan
Dialog Semiconductor Taiwan
Phone: +886 281 786 222

Email: enquiry@diasemi.com
Web site: www.dialog-semiconductor.com

Hong Kong
Dialog Semiconductor Hong Kong
Phone: +852 2607 4271

Korea
Dialog Semiconductor Korea
Phone: +82 2 3469 8200

Email: enquiry@diasemi.com
Web site: www.dialog-semiconductor.com

China (Shenzhen)
Dialog Semiconductor China
Phone: +86 755 2981 3669

China (Shanghai)
Dialog Semiconductor China
Phone: +86 21 5424 9058

Contacting Dialog Semiconductor

United Kingdom (Headquarters)
Dialog Semiconductor (UK) LTD
Phone: +44 1793 757700

Germany
Dialog Semiconductor GmbH
Phone: +49 7021 805-0

The Netherlands
Dialog Semiconductor B.V.
Phone: +31 73 640 8822

Email: enquiry@diasemi.com
Web site: www.dialog-semiconductor.com

North America
Dialog Semiconductor Inc.
Phone: +1 408 845 8500

Japan
Dialog Semiconductor K. K.
Phone: +81 3 5769 5100

Taiwan
Dialog Semiconductor Taiwan
Phone: +886 281 786 222

Email: enquiry@diasemi.com
Web site: www.dialog-semiconductor.com

Hong Kong
Dialog Semiconductor Hong Kong
Phone: +852 2607 4271

Korea
Dialog Semiconductor Korea
Phone: +82 2 3469 8200

Email: enquiry@diasemi.com
Web site: www.dialog-semiconductor.com

China (Shenzhen)
Dialog Semiconductor China
Phone: +86 755 2981 3669

China (Shanghai)
Dialog Semiconductor China
Phone: +86 21 5424 9058

Contacting Dialog Semiconductor

United Kingdom (Headquarters)
Dialog Semiconductor (UK) LTD
Phone: +44 1793 757700

Germany
Dialog Semiconductor GmbH
Phone: +49 7021 805-0

The Netherlands
Dialog Semiconductor B.V.
Phone: +31 73 640 8822

Email: enquiry@diasemi.com
Web site: www.dialog-semiconductor.com

North America
Dialog Semiconductor Inc.
Phone: +1 408 845 8500

Japan
Dialog Semiconductor K. K.
Phone: +81 3 5769 5100

Taiwan
Dialog Semiconductor Taiwan
Phone: +886 281 786 222

Email: enquiry@diasemi.com
Web site: www.dialog-semiconductor.com

Hong Kong
Dialog Semiconductor Hong Kong
Phone: +852 2607 4271

Korea
Dialog Semiconductor Korea
Phone: +82 2 3469 8200

Email: enquiry@diasemi.com
Web site: www.dialog-semiconductor.com

China (Shenzhen)
Dialog Semiconductor China
Phone: +86 755 2981 3669

China (Shanghai)
Dialog Semiconductor China
Phone: +86 21 5424 9058
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